IPC ASSOCIATION CONNECTION ELECTRONICS INDUSTRIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				under both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowel level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Form Typ Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					eous Materi	ials and Mfg Information				
Supplier Inform	nation															
Company name* Com			Company uni	Company unique ID			Unique ID Authority					Response Date*				
onsemi											2025-06-08					
Contact Name		Title - Contac	Title - Contact			Phone - Contact*					Email - Contact*					
Product-Env-Stew	ards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Authorized Repres	Title - Representative			I	Phone - Representative*				Email - Representative*							
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Request	Requester Item Number Mfr Item		mem Number Mfr Item Name					te Ve	rsion Manufacturing Site		V	eight*	UOM	Unit Ty		
		NOIP1SN0500A-QT		PYTHON 500 Mono LVDS, Tape on Lid		on Lid	2025-06-08		,	THA		10)56.06	mg	Each	
Manufacturing	Process Information	on														
Terminal	l Plating / Grid Array Material		Terminal Base Alloy J		J-STD-020 MSL	020 MSL Rating		Peak Process Body Temperature		re Max Time at Peak Temper		Temperatu	rature Number of Reflow Cycles			
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 3		3		260		C 30			second	s 3			
Comments																
TTENTION: MS	L 3 Rated item requires	Bake and D	Ory Pack (after	electrical test)												
For more informati	on regarding material co	mposition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Ceramic Substrate	665.12	mg	Supplier	Cobalt (Co)	7440-48-4		0.0665	mg
			Supplier	Molybdenum (Mo)	7439-98-7		0.0665	mg
			Supplier	Tungsten (W)	7440-33-7		7.9814	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		41.9026	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		589.2963	mg
			В	Nickel (Ni)	7440-02-0		1.8623	mg
			Supplier	Gold (Au)	7440-57-5		1.3302	mg
			Supplier	Chromium Trioxide (Cr2O3)	1308-38-9		22.614	mg
Die	119.22	mg	Supplier	Silicon (Si)	7440-21-3		119.22	mg
Die Attach	48.62	mg	Supplier	Silver (Ag)	7440-22-4		41.327	mg
			Supplier	Epoxy resins	129915-35-1		7.293	mg
Glass Attach Epoxy	3.41	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		0.2933	mg
			Supplier	N-[3- (Trimethoxysilyl)propyl]ethylenediamine	1760-24-3		0.2353	mg
			Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		1.4186	mg
			Supplier	4,4'-Diaminodiphenyl Sulfone (DDS-4,4')	80-08-0		0.0102	mg
			Supplier	Filler (SiO2?C2H6Cl2Si)	68611-44-9		1.364	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0887	mg
Glass Lid /Cap	219.48	mg	Supplier	Boron Trioxide (B2O3)	1303-86-2		18.4363	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		130.5467	mg
			Supplier	Barium Monoxide (BaO)	1304-28-5		17.9974	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		17.3828	mg
			Supplier	Calcium Monoxide (CaO)	1305-78-8		35.1168	mg
Wire Bond - Al	0.21	mg	Supplier	Aluminum (Al)	7429-90-5		0.21	mg